Panasonic ideas for life



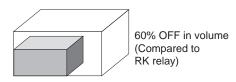
RS RELAYS (ARS)



FEATURES

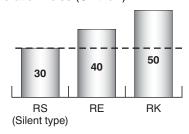
1. Super miniature design

 $14 \times 8.6 \times 7.2~mm$ $.551 \times .339 \times .283$ inch (standard PC board terminal)



2. Lineup includes silent type. (75 Ω type only)

Operation noise (Unit: dB)



3. Excellent high frequency characteristics

Impedance: 50Ω

(Standard PC board terminal)

Frequency	to 900 MHz	to 3 GHz
V. S. W. R. (Max.)	1.20	1.40
Insertion loss (dB, Max.)	0.10	0.35
Isolation (dB, Min.)	60	35

• Impedance: 75Ω

(Standard PC board terminal)

•			
Frequency	to 900 MHz	to 3 GHz	
V. S. W. R. (Max.)	1.15	1.40	
Insertion loss (dB, Max.)	0.10	0.30	
Isolation (dB, Min.)	60	30	

Impedance: 50Ω (Surface-mount terminal)

Frequency	to 900 MHz	to 3 GHz	
V. S. W. R. (Max.)	1.20	1.40	
Insertion loss (dB, Max.)	0.20	0.40	
Isolation (dB. Min.)	55	30	

• Impedance: 75Ω

(Surface-mount terminal)

Frequency	to 900 MHz	to 3 GHz
V. S. W. R. (Max.)	1.20	1.50
Insertion loss (dB, Max.)	0.20	0.50
Isolation (dB, Min.)	55	30

4. Lineup includes surface-mount terminal type

E and Y layouts available.

5. Lineup includes reversed contact

Great design freedom is possible using reversed contact type in which the positions of the N.O. and N.C. contacts are switched.

TYPICAL APPLICATIONS

1. Broadcasting and video equipment markets

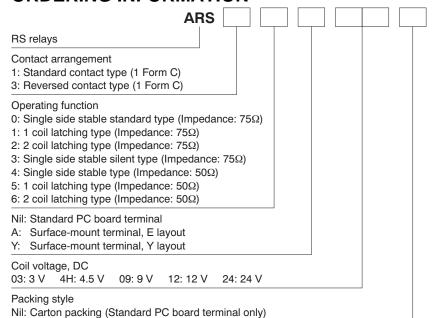
- · Digital broadcasting equipment
- STB/tuner, etc.
- 2. Mobile phone base stations
- 3. Communications market
- Antenna switching
- All types of wireless devices

4. Measurement equipment market

Spectrum analyzer and oscilloscope,

ORDERING INFORMATION

Tube packing (Surface-mount terminal only)



Tape and reel packing (picked from 2-pin side) (Surface-mount terminal only) Tape and reel packing (picked from 18-pin side) (Surface-mount terminal only)

ds 61314 en rs: 010611J

TYPES

1. Standard PC board terminal and standard contact type

Impedance Nominal coil		Part No.					
impedance	voltage	Single side stable type		1 coil latching type			2 coil latching type
50Ω	3 V DC	ARS1403		ARS	1503		ARS1603
	4.5 V DC	ARS144H		ARS	154H		ARS164H
	9 V DC	ARS1409		ARS	1509		ARS1609
	12 V DC	ARS1412		ARS1512			ARS1612
	24 V DC	ARS1424		ARS1524		ARS1624	
	Naminal sail	Part No.					
Impedance	Nominal coil voltage	Standard type					Silent type
		Single side stable type	1 cc	oil latching type	2 coil latching t	уре	Single side stable type
	3 V DC	ARS1003	ARS1103		ARS1203		ARS1303
	4.5 V DC	ARS104H		ARS114H	ARS114H ARS124H		ARS134H
75Ω	9 V DC	ARS1009		ARS1109	ARS1209		ARS1309
	12 V DC	ARS1012		ARS1112	ARS1212		ARS1312
	24 V DC	ARS1024		ARS1124	24 ARS1224		ARS1324

Standard packing: 50 pcs. in an inner package; 500 pcs. in an outer package

2. Standard PC board terminal and reversed contact type

Immadanaa	Nominal coil		Part No.					
Impedance 50Ω	voltage	Single side stable type	е	1 coil late	ching type		2 coil latching type	
	3 V DC	ARS3403		ARS	3503		ARS3603	
50Ω	4.5 V DC	ARS344H		ARS	354H		ARS364H	
	9 V DC	ARS3409		ARS3509			ARS3609	
	12 V DC	ARS3412		ARS3512		ARS3612		
	24 V DC	ARS3424		ARS3524			ARS3624	
		Part No.						
Impedance	Nominal coil	Standard type		andard type			Silent type	
	voltage	Single side stable type	1 coi	il latching type	2 coil latching t	уре	Single side stable type	
	3 V DC	ARS3003	A	ARS3103	ARS3203		ARS3303	
	4.5 V DC	ARS304H	P	ARS314H	ARS324H		ARS334H	
75Ω	9 V DC	ARS3009	F	ARS3109	ARS3209		ARS3309	
	12 V DC	ARS3012	l l	ARS3112	ARS3212		ARS3312	
	24 V DC	ARS3024	,	ARS3124	ARS3224		ARS3324	

Standard packing: 50 pcs. in an inner package; 500 pcs. in an outer package

3. Surface-mount terminal and standard contact type, E layout

lmnadanaa	Nominal coil	Part No.				
Impedance	voltage	Single side stable type	1 coil latching type	2 coil latching type		
	3 V DC	ARS14A03□	ARS15A03□	ARS16A03□		
	4.5 V DC	ARS14A4H□	ARS15A4H□	ARS16A4H□		
50Ω	9 V DC	ARS14A09□	ARS15A09□	ARS16A09□		
	12 V DC	ARS14A12□	ARS15A12□	ARS16A12□		
	24 V DC	ARS14A24□	ARS15A24□	ARS16A24□		
	3 V DC	ARS10A03□	ARS11A03□	ARS12A03□		
	4.5 V DC	ARS10A4H□	ARS11A4H□	ARS12A4H□		
75Ω	9 V DC	ARS10A09□	ARS11A09□	ARS12A09□		
	12 V DC	ARS10A12□	ARS11A12□	ARS12A12□		
	24 V DC	ARS10A24□	ARS11A24□	ARS12A24□		

Standard packing: 40 pcs. in an inner package (tube); 1,000 pcs. in an outer package

Standard packing: 500 pcs. in an inner package (tape and reel); 500 pcs. in an outer package

Note: The box at the end of a part number shows where packing type is indicated. If there is no indication, tube packing will be used. If "X" or "Z" is added, tape and reel packing will be used. Example: ARS14A03 (tube packing), ARS14A03X (tape and reel packing)

4. Surface-mount terminal and standard contact type, Y layout

l	Nominal coil		Part No.				
Impedance	voltage	Single side stable type	1 coil latching type	2 coil latching type			
50Ω	3 V DC	ARS14Y03□	ARS15Y03□	ARS16Y03□			
	4.5 V DC	ARS14Y4H□	ARS15Y4H□	ARS16Y4H□			
	9 V DC	ARS14Y09□	ARS15Y09□	ARS16Y09□			
	12 V DC	ARS14Y12□	ARS15Y12□	ARS16Y12□			
	24 V DC ARS14Y24□		ARS15Y24□	ARS16Y24□			
	3 V DC	ARS10Y03□	ARS11Y03□	ARS12Y03□			
	4.5 V DC	ARS10Y4H□	ARS11Y4H□	ARS12Y4H□			
75Ω	9 V DC	ARS10Y09□	ARS11Y09□	ARS12Y09□			
	12 V DC	ARS10Y12□	ARS11Y12□	ARS12Y12□			
	24 V DC	ARS10Y24□	ARS11Y24□	ARS12Y24□			

Standard packing: 40 pcs. in an inner package (tube); 1,000 pcs. in an outer package

Standard packing: 500 pcs. in an inner package (tape and reel); 500 pcs. in an outer package

Note: The box at the end of a part number shows where packing type is indicated. If there is no indication, tube packing will be used. If "X" or "Z" is added, tape and reel packing will be used. Example: ARS14Y03 (tube packing), ARS14Y03X (tape and reel packing)

5. Surface-mount terminal and reversed contact type, E layout

lmnadanaa	Nominal coil	Part No.				
Impedance	voltage	Single side stable type	1 coil latching type	2 coil latching type		
	3 V DC	ARS34A03□	ARS35A03□	ARS36A03□		
	4.5 V DC	ARS34A4H□	ARS35A4H□	ARS36A4H□		
50Ω	9 V DC	ARS34A09□	ARS35A09□	ARS36A09□		
	12 V DC	ARS34A12□	ARS35A12□	ARS36A12□		
	24 V DC	ARS34A24□	ARS35A24□	ARS36A24□		
	3 V DC	ARS30A03□	ARS31A03□	ARS32A03□		
	4.5 V DC	ARS30A4H□	ARS31A4H□	ARS32A4H□		
75Ω	9 V DC	ARS30A09□	ARS31A09□	ARS32A09□		
	12 V DC	ARS30A12□	ARS31A12□	ARS32A12□		
	24 V DC	ARS30A24□	ARS31A24□	ARS32A24□		

Standard packing: 40 pcs. in an inner package (tube); 1,000 pcs. in an outer package
Standard packing: 500 pcs. in an inner package (tape and reel); 500 pcs. in an outer package
Note: The box at the end of a part number shows where packing type is indicated. If there is no indication, tube packing will be used.

If "X" or "Z" is added, tape and reel packing will be used. Example: ARS34A03 (tube packing), ARS34A03X (tape and reel packing)

6. Surface-mount terminal and reversed contact type, Y layout

Impedance	Nominal coil	Part No.				
impedance	voltage	Single side stable type	1 coil latching type	2 coil latching type		
	3 V DC	ARS34Y03□	ARS35Y03□	ARS36Y03□		
	4.5 V DC	ARS34Y4H□	ARS35Y4H□	ARS36Y4H□		
50Ω	9 V DC	ARS34Y09□	ARS35Y09□	ARS36Y09□		
	12 V DC	ARS34Y12□	ARS35Y12□	ARS36Y12□		
	24 V DC	ARS34Y24□	ARS35Y24□	ARS36Y24□		
	3 V DC	ARS30Y03□	ARS31Y03□	ARS32Y03□		
	4.5 V DC	ARS30Y4H□	ARS31Y4H□	ARS32Y4H□		
75Ω	9 V DC	ARS30Y09□	ARS31Y09□	ARS32Y09□		
	12 V DC	ARS30Y12□	ARS31Y12□	ARS32Y12□		
	24 V DC	ARS30Y24□	ARS31Y24□	ARS32Y24□		

Standard packing: 40 pcs. in an inner package (tube); 1,000 pcs. in an outer package
Standard packing: 500 pcs. in an inner package (tape and reel); 500 pcs. in an outer package
Note: The box at the end of a part number shows where packing type is indicated. If there is no indication, tube packing will be used.

If "X" or "Z" is added, tape and reel packing will be used. Example: ARS34Y03 (tube packing), ARS34Y03X (tape and reel packing)

RATING

1. Coil data

1) Single side stable type

Nominal coil voltage	Pick-up voltage (at 20°C 68°F)	Drop-out voltage (at 20°C 68°F)	Nominal operating current [±10%] (at 20°C 68°F)	Coil resistance [±10%] (at 20°C 68°F)	Nominal operating power	Max. allowable voltage (at 60°C 140°F)	
3 V DC	75%V or less of		66.7 mA	45 Ω			
4.5 V DC		10%V or more of	44.4 mA	101.3Ω			
9 V DC	nominal voltage	nominal voltage	22.2 mA	405 Ω	200 mW	110%V or less of nominal voltage	
12 V DC	(Initial)	(Initial) (Initial)	(Initial)	16.7 mA	720 Ω		nominal voltage
24 V DC			8.3 mA	2,880 Ω			

2) 1 coil latching type

Nominal coil voltage	Set voltage (at 20°C 68°F)	Reset voltage (at 20°C 68°F)	Nominal operating current [±10%] (at 20°C 68°F)	Coil resistance [±10%] (at 20°C 68°F)	Nominal operating power	Max. allowable voltage (at 60°C 140°F)
3 V DC		75%V or less of 75%V or less of	66.7 mA	45 Ω	200 mW	110%V or less of nominal voltage
4.5 V DC	75%V or less of		44.4 mA	101.3Ω		
9 V DC	nominal voltage	nominal voltage	22.2 mA	405 Ω		
12 V DC	(Initial)	(Initial)	16.7 mA	720 Ω		
24 V DC			8.3 mA	2,880 Ω		

3) 2 coil latching type

Nominal coil voltage	Set voltage (at 20°C 68°F)	Reset voltage (at 20°C 68°F)	Nominal operating current [±10%] (at 20°C 68°F)	Coil resistance [±10%] (at 20°C 68°F)	Nominal operating power	Max. allowable voltage (at 60°C 140°F)
3 V DC	75%V or less of nominal voltage (Initial)	75%V or less of nominal voltage (Initial)	133.3 mA	22.5Ω	400 mW	110%V or less of nominal voltage
4.5 V DC			88.9 mA	50.6Ω		
9 V DC			44.4 mA	202.5Ω		
12 V DC			33.3 mA	360 Ω		
24 V DC			16.7 mA	1,440 Ω		

RS

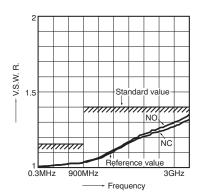
Arrangement	2. Specification		Item	Specifications	
Contact material Contact resistance (initial) Contact resistance (initial) Max. 100 mt2 (By voltage drop 10 V AC 10mA) Nominal switching capacity 1W (at 3 GHz, Impedance: 5075Ω, V.S.W.R.: Max. 1.4), 10 mA 24 V DC (resistive data for the contact carrying power data 10W (at 3 GHz, Impedance: 5075Ω, V.S.W.R.: Max. 1.4) Max. switching current O.5 A DC Max. 1.0000MW V.S.W.R. Max. 1.20900MHz, Max. 1.40/3GHz (Standard PC board terminal) Max. 1.20900MHz, Max. 1.40/3GHz (Standard PC board terminal) Max. 1.20900MHz, Max. 0.358/3GHz (Standard PC board terminal) Max. 0.208B/300MHz, Min. 308B/3GHz (Surface-mount terminal) Max. 0.208B/300MHz, Min. 308B/3GHz (Surface-mount terminal) Max. 0.208B/300MHz, Min. 308B/3GHz (Surface-mount terminal) Max. 1.20900MHz, Min. 308B/3GHz (Surface-mount terminal) Max. 0.208B/300MHz, Min. 308B/3GHz (Surface-mount terminal) Max. 0.208B/300MHz, Min. 308B/3GHz (Surface-mount terminal) Max. 0.208B/300MHz, Min. 308B/3GHz (Surface-mount terminal) Max. 1.20900MHz, Min. 308B/3GHz (Surface-mount terminal) Min. 608B/300MHz, Min. 308B/3GHz (Surface-mo		Arrangement	1011	•	
Contact resistance (Initial) Max. 100 mΩ (By voltage drop 10 V AC 10mA)	Contact				
Nominal switching capacity	Contact				
Contact carrying power Max. 10W (at 3GHz, Impedance: 50/75Ω, V.S.W.R.: Max. 1.4)			,		
Max. switching outrent 0.5 A DC					
Max. switching current 0.5 A DC		-			
Nominal operating 1 coil latching type 200mW	Pating				
Notified power 1 coll latching type 200mW 2 coll latching type 2 coll latching type 400mW 3 coll latching type 400mW	rtaurig				
Power 2 coil latching type 400mW Wax. 1.20/900MHz, Max. 1.40/3GHz (Standard PC board terminal) Wax. 1.20/900MHz, Max. 1.40/3GHz (Standard PC board terminal) Wax. 1.20/900MHz, Max. 1.40/3GHz (Standard PC board terminal) Wax. 2.00/900MHz, Max. 0.40/900MHz, Max. 0.40/900MHz Wax. 0.40		operating	71		
High frequency characteristics, Impedance: 500 (Initial) Insertion loss (without D.U.T. board's loss) Max. 0.10d8/900MHz, Max. 0.35d8/3GHz (Standard PC board terminal) Max. 0.20d8/900MHz, Max. 0.40d8/3GHz (Standard PC board terminal) Max. 0.20d8/900MHz, Max. 0.40d8/3GHz (Standard PC board terminal) Max. 0.20d8/900MHz, Max. 0.40d8/3GHz (Standard PC board terminal) Min. 60d8/900MHz, Max. 0.40d8/3GHz (Standard PC board terminal) Min. 55d8/95dPt. Max. 0.35d8/3GHz (Standard PC board terminal) Min. 55d8/95dPt. Max. 0.50d8/3GHz (Standard PC board terminal) Min. 55d8/95dPt. Max. 0.50d8/3GHz (Standard PC board terminal) Min. 55d8/95dPt. Max. 0.50d8/3GHz (Standard PC board terminal) Max. 1.20/900MHz, Max. 1.50/3GHz (Standard PC board terminal) Max. 0.20d8/900MHz, Max. 0.50d8/3GHz (Standard PC board terminal) Max. 0.20d8/900MHz, Max. 0.50d8/3GHz (Standard PC board terminal) Max. 0.20d8/900MHz, Max. 0.50d8/3GHz (Standard PC board terminal) Max. 0.50d8/3GH			- 11		
theracteristics, impedance; 500, finitial) Insertion loss (without D.U.T. board's loss) Max. 0.10dB/900MHz, Max. 0.40dB/3GHz (Standard PC board terminal) Min. 55dB/900MHz, Min. 30dB/3GHz (Standard PC board terminal) Min. 55dB/900MHz, Max. 1.50/3GHz (Standard PC board terminal) Min. 55dB/900MHz, Max. 1.50/3GHz (Standard PC board terminal) Min. 55dB/900MHz, Min. 30dB/3GHz (Standard PC board terminal) Min. 34dB/2 (Standard PC board termina	Lligh fraguency	2 con fatching type		Max. 1.20/900MHz, Max. 1.40/3GHz (Standard PC board terminal)	
Isolation Min. 55dB/900MHz, Min. 30dB/3GHz (Surface-mount terminal)	characteristics,	Insertion loss (without D.U.T. board's loss)		Max. 0.10dB/900MHz, Max. 0.35dB/3GHz (Standard PC board terminal)	
High frequency characteristics mispedance: 75Ω (Initial) Insertion loss (without D.U.T. board's loss) Max. 0.10dB/900MHz, Max. 0.50dB/3GHz (Standard PC board terminal) mispedance: 75Ω (Initial) Isolation Insulation resistance (Initial) Min. 60dB/900MHz, Min. 30dB/3GHz (Standard PC board terminal) Min. 55dB/900MHz, Min. 30dB/9GHz (Tarli-wave pulse of sine wave: 10mA) Min. 10m (Nominal voltage applied to the coil, excluding contact bounce time) Min. 10m (Nominal voltage applied to the coil, excluding contact bounce time) Min. 10m (Nominal voltage applied to the coil, excluding contact bounce time) Min. 10m (Nominal voltage applied to the coil, excluding contact bounce time) Min. 10m (Nominal voltage applied to the coil, excluding contact bounce time) Min. 30m/s² (Half-wave pulse of sine wave: 11 ms, detection time: 10µs) Destructive Min. 980 m/s² (Half-wave pulse of sine wave: 11 ms, detection time: 10µs) Destructive Min. 980 m/s² (Half-wave pulse of sine wave: 11 ms, detection time: 10µs) Min. 30m/s² (Malfalf-wave pulse of sine wave		Isolation		Min. 60dB/900MHz, Min. 35dB/3GHz (Standard PC board terminal)	
characteristics, Impedance: 75Ω (Initial) Insertion loss (without D.U.T. board's loss) Insertion loss (without D.U.T. board's loss) Impedance: 75Ω (Initial) Isolation Isolation Isolation Isolation Insulation resistance (Initial) Insulation resistance (Initial) Breakdown voltage (Initial) Breakdown voltage (Initial) Breakdown voltage (Initial) Between contact and earth terminal 500 Vrms for 1min. (Detection current: 10mA) Detween contact and coil 1,000 Vrms for 1min. (Detection current: 10mA) Detween contact and coil 1,000 Vrms for 1min. (Detection current: 10mA) Detween contact and coil 1,000 Vrms for 1min. (Detection current: 10mA) Detween contact and coil 1,000 Vrms for 1min. (Detection current: 10mA) Detween contact and coil 1,000 Vrms for 1min. (Detection current: 10mA) Detween contact and coil 1,000 Vrms for 1min. (Detection current: 10mA) Detween contact and coil 1,000 Vrms for 1min. (Detection current: 10mA) Max. 60°C 140°F (By resistive method, nominal voltage applied to the coil, excluding contact bounce time) Max. 60°C 140°F Release time (at 20°C 68°F) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Without diode) Set time and Reset time (at 20°C 68°F) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Without diode) Shock resistance Penctional Penctional Destructive Min. 986 m/s² (Half-wave pulse of sine wave: 11 ms, detection time: 10µs) Destructive Min. 986 m/s² (Half-wave pulse of sine wave: 6 ms) Destructive Min. 980 m/s² (Half-wave pulse of sine wave: 6 ms) Functional Penctional Functional Penctional Pe	High frequency	V.S.W.R.			
Isolation Iso	characteristics,	Insertion loss (without D.U.T. board's loss)			
Breakdown voltage (Initial) Between open contacts 500 Vrms for 1min. (Detection current: 10mA) Between contact and earth terminal 500 Vrms for 1min. (Detection current: 10mA) Between contact and coil 1,000 Vrms for 1min. (Detection current: 10mA) Max. 60°C 140°F Max. 60°C 140°F Max. 60°C 140°F (By resistive method, nominal voltage applied to the coil, excluding contact bounce time) Max. 6 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 6 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 6 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 6 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 6 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 6 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Min. 10° (Half-wave pulse of sine wave: 11 ms, detection time: 10µs) Destructive Min. 196 (Half-wave pulse of sine wave: 6 ms) Min. 10° (Sh 12 at double amplitude of 3 mm (Detection time: 10µs) Destructive Min. 55 Hz at double amplitude of 5 mm Destructive Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Min. 54° (By 12 at 32° (Half-wave pulse of sine wave: 11 ms, detection time: 10µs) Destructive Min. 55 Hz at double amplitude of 3 mm (Detection time: 10µs) Destructive Min. 55 Hz at double amplitude of 5 mm Destructive Min. 50° (Standard PC board terminal), Min. 3×10° (Surface-mount terminal	(Initial)	Isolation			
Between contact and earth terminal 500 Vrms for 1min. (Detection current: 10mA)		Insulation res	istance (Initial)	Min. $100M\Omega$ (at $500V$ DC, Measurement at same location as "Breakdown voltage" section	
Comparation		Breakdown	Between open contacts	500 Vrms for 1min. (Detection current: 10mA)	
Temperature rise (at 20°C 68°F) Max. 60°C 140°F (By resistive method, nominal voltage applied to the coil, excluding contact bounce time) Release time (at 20°C 68°F) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 60°C 140°F (By resistive method, nominal voltage applied to the coil, excluding contact bounce time) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Min. 196 m/s² (Half-wave pulse of sine wave: 11 ms, detection time: 10μs) Destructive Min. 980 m/s² (Half-wave pulse of sine wave: 6 ms) Vibration resistance Destructive Nin. 980 m/s² (Half-wave pulse of sine wave: 6 ms) Vibration resistance Destructive 10 to 55 Hz at double amplitude of 3 mm (Detection time: 10μs) Expected life Mechanical life Min. 10° (Standard PC board terminal), Min. 3×10° (Surface-mount terminal) (10∨ DC 10mA resistive load)/Min. 3×10° (Surface-mount terminal) (10∨ DC 10mA resistive loa		voltage	Between contact and earth terminal	500 Vrms for 1min. (Detection current: 10mA)	
Temperature rise (at 20°C 68°F) Operate time (at 20°C 68°F) Release time (at 20°C 68°F) Set time and Reset time (at 20°C 68°F) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) (without diode) Set time and Reset time (at 20°C 68°F) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) (without diode) Set time and Reset time (at 20°C 68°F) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) (without diode) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) (without diode) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) (min. 196 m/s² (Half-wave pulse of sine wave: 11 ms, detection time: 10μs) Destructive Min. 980 m/s² (Half-wave pulse of sine wave: 6 ms) Vibration resistance Destructive Min. 980 m/s² (Half-wave pulse of sine wave: 6 ms) Destructive 10 to 55 Hz at double amplitude of 3 mm (Detection time: 10μs) Standard type Standard type Standard type Approx. 40dB Single side stable standard type only) Approx. 30dB Min. 5×10° (at 180 cpm) Single side stable standard type Min. 10° (at 180 cpm) Min. 10° (Standard PC board terminal), Min. 3×10° (Surface-mount terminal) (10∨ DC 10mA resistive load)/Min. 3×10° (24∨ DC 10mA resistive load) Min. 10° (Standard PC board terminal), Min. 3×10° (Surface-mount terminal) (10∨ DC 10mA 24∨ DC resistive load) Min. 3×10° (10mA 24∨ DC resistive load) Ambient temperature: -40 to 70°C -40°F to 158°F (Single side stable standard and Latching type)		(Initial)	Between contact and coil	1,000 Vrms for 1min. (Detection current: 10mA)	
Release time (at 20°C 68°F) Release time (at 20°C 68°F) Max. 6 ms (Nominal voltage applied to the coil, excluding contact bounce time) (without diode) Set time and Reset time (at 20°C 68°F) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time) Mechanical characteristics Mechanical characteristics Functional Destructive Min. 196 m/s² (Half-wave pulse of sine wave: 11 ms, detection time: 10μs) Punctional Destructive Min. 980 m/s² (Half-wave pulse of sine wave: 6 ms) Vibration resistance Destructive Destructive 10 to 55 Hz at double amplitude of 3 mm (Detection time: 10μs) Standard type Silent type (75Ω, PC board terminal type only) Approx. 40dB Single side stable standard type Min. 5×10° (at 180 cpm) Latching type Min. 10° (at 180 cpm) Min. 10° (Standard PC board terminal), Min. 3×10° (Surface-mount terminal) (10∨ DC 10mA resistive load)/Min. 3×10° (24∨ DC 10mA resistive load)/Min. 3×10° (10mA 24∨ DC resistive load)/Min. 3×10° (3urface-mount terminal) (10∨ DC 10mA 24∨ DC resistive load)/Min. 3×10° (3urface-mount terminal) (10∨ DC 10mA 24∨ DC resistive load)/Min. 3×10° (3urface-mount terminal) (10∨ DC 10mA 24∨ DC resistive load)/Min. 3×10° (3urface-mount terminal) (10∨ DC 10mA 24∨ DC resistive load)/Min. 3×10° (3urface-mount terminal) (10∨ DC 10mA 24∨ DC resistive load) (10∨ 10∨ 10∨ 10∨ 10∨ 10∨ 10∨ 10∨ 10∨ 10∨		Temperature rise (at 20°C 68°F)		Max. 60°C 140°F (By resistive method, nominal voltage applied to the coil, contact carrying current: 10mA)	
Set time and Reset time (at 20°C 68°F) Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time)		Operate time	(at 20°C 68°F)	Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time)	
Shock resistance Destructive Min. 196 m/s² (Half-wave pulse of sine wave: 11 ms, detection time: 10μs)		Release time (at 20°C 68°F)			
Mechanical characteristics Destructive Min. 980 m/s² (Half-wave pulse of sine wave: 6 ms) Vibration resistance Functional 10 to 55 Hz at double amplitude of 3 mm (Detection time: 10μs) Operation noise* Standard type Approx. 40dB Single side stable standard type only) Approx. 30dB Mechanical life Single side stable standard type only) Min. 5×10° (at 180 cpm) Expected life Single side stable silent type Min. 10° (at 180 cpm) Expected life Min. 10° (Standard PC board terminal), Min. 3×10° (Surface-mount terminal) (10V DC 10mA resistive load)/Min. 3×10° (24V DC 10mA resistive load) Min. 3×10° (Surface-mount terminal) (10V, at 3GHz, Impedance: 50Ω, V.S.W.R: Max. 1.4) (at 20 cpm) Fig. 2 type Min. 3×10° (10mA 24V DC resistive load) Min. 3×10° (V.S.W.R: Max. 1.4) (at 20 cpm) Ambient temperature: -40 to 70°C -40°F to 158°F (Single side stable standard and Latching type)		Set time and Reset time (at 20°C 68°F)		Max. 10 ms (Nominal voltage applied to the coil, excluding contact bounce time)	
whethalitätich characteristics Vibration resistance Functional 10 to 55 Hz at double amplitude of 3 mm (Detection time: 10μs) Operation noise* Standard type Approx. 40dB Silent type (75Ω, PC board terminal type only) Approx. 30dB Mechanical life Single side stable standard type Min. 5×10 ⁶ (at 180 cpm) Expected life Min. 10 ⁶ (at 180 cpm) Expected life Min. 10 ⁶ (Standard PC board terminal), Min. 3×10 ⁵ (Surface-mount terminal) (10V DC 10mA resistive load)/Min. 3×10 ⁵ (24V DC 10mA resistive load) Min. 10 ⁶ (Standard PC board terminal), Min. 3×10 ⁵ (Surface-mount terminal) (1W, at 3GHz, Impedance: 50Ω, V.S.W.R: Max. 1.4) (at 20 cpm) 75Ω type Min. 3×10 ⁵ (10mA 24V DC resistive load) Min. 3×10 ⁵ (V.S.W.R: Max. 1.4) (at 20 cpm) Ambient temperature: -40 to 70°C -40°F to 158°F (Single side stable standard and Latching type)		1	Functional	Min. 196 m/s² (Half-wave pulse of sine wave: 11 ms, detection time: 10μs)	
Destructive 10 to 55 Hz at double amplitude of 5 mm Standard type Approx. 40dB	Mechanical		Destructive	Min. 980 m/s² (Half-wave pulse of sine wave: 6 ms)	
Standard type Approx. 40dB Signet type (75Ω, PC board terminal type only) Approx. 30dB Mechanical life Single side stable standard type Min. 5×10 ⁶ (at 180 cpm) Expected life Min. 10 ⁶ (at 180 cpm) Expected life Min. 10 ⁶ (Standard PC board terminal), Min. 3×10 ⁵ (Surface-mount terminal) (10V DC 10mA resistive load)/Min. 3×10 ⁵ (24V DC 10mA resistive load) Min. 10 ⁶ (Standard PC board terminal), Min. 3×10 ⁵ (Surface-mount terminal) (1W, at 3GHz, Impedance: 50Ω, V.S.W.R: Max. 1.4) (at 20 cpm) 75Ω type Min. 3×10 ⁵ (10mA 24V DC resistive load) Min. 3×10 ⁵ (1W, at 3GHz, Impedance: 75Ω, V.S.W.R: Max. 1.4) (at 20 cpm) Ambient temperature: -40 to 70°C -40°F to 158°F (Single side stable standard and Latching type)		Vibration	Functional	10 to 55 Hz at double amplitude of 3 mm (Detection time: 10μs)	
Silent type (75Ω, PC board terminal type only) Approx. 30dB		resistance	Destructive	10 to 55 Hz at double amplitude of 5 mm	
Silent type (75Ω, PC board terminal type only) Approx. 30dB	Operation noise*	Standard type)	Approx. 40dB	
Mechanical life Single side stable silent type Min. 10 ⁶ (at 180 cpm)		Silent type (75 Ω , PC board terminal type only)		Approx. 30dB	
Expected life Latching type Min. 10° (at 180 cpm)	Expected life		Single side stable standard type	Min. 5×10 ⁶ (at 180 cpm)	
Expected life Electrical life Electrical life Electrical life Electrical life Electrical life Electrical life FoΩ type Min. 106 (Standard PC board terminal), Min. 3×105 (Surface-mount terminal) (10V DC 10mA resistive load)/Min. 3×105 (24V DC 10mA resistive load) Min. 106 (Standard PC board terminal), Min. 3×105 (Surface-mount terminal) (1W, at 3GHz, Impedance: 50Ω, V.S.W.R: Max. 1.4) (at 20 cpm) Min. 3×105 (10mA 24V DC resistive load) Min. 3×105 (1W, at 3GHz, Impedance: 75Ω, V.S.W.R: Max. 1.4) (at 20 cpm) Ambient temperature: -40 to 70°C -40°F to 158°F (Single side stable standard and Latching type)			Single side stable silent type	Min. 10 ⁶ (at 180 cpm)	
Expected life Electrical life Flectrical life Electrical life 50Ω type (10V DC 10mA resistive load)/Min. 3×10⁵ (24V DC 10mA resistive load) Min. 10⁶ (Standard PC board terminal), Min. 3×10⁶ (Surface-mount terminal) (1W, at 3GHz, Impedance: 50Ω, V.S.W.R: Max. 1.4) (at 20 cpm) Min. 3×10⁶ (10mA 24V DC resistive load) Min. 3×10⁶ (30mA 24V DC resistive load) Min. 3×10⁶ (10mA 24V DC resistive load) Ambient temperature: -40 to 70⋄ C -40⋄ F to 158⋄ F (Single side stable standard and Latching type)			Latching type	Min. 10 ⁶ (at 180 cpm)	
Min. 3×10 ⁵ (1W, at 3GHz, Impedance: 75Ω, V.S.W.R: Max. 1.4) (at 20 cpm) Ambient temperature: –40 to 70°C –40°F to 158°F (Single side stable standard and Latching type)		Electrical life	50Ω type	(10V DC 10mA resistive load)/Min. 3×10 ⁵ (24V DC 10mA resistive load) Min. 10 ⁶ (Standard PC board terminal), Min. 3×10 ⁵ (Surface-mount terminal)	
(Single side stable standard and Latching type)			75Ω type		
	Conditions	Conditions for	r operation, transport and storage	(Single side stable standard and Latching type) Ambient temperature: -40 to 60°C -40°F to 140°F (Single side stable silent type)	

^{*} Measured the operation noise of the relay alone (with diodes at both ends of the coil) 30cm away from top side, by the A-weighted, FAST method while applying the rated voltage.

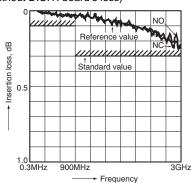
(Reference) Operation noise of RK relay (existing model): Approx. 50dB

REFERENCE DATA

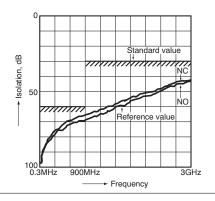
- 1.-(1) High frequency characteristics (Impedance: 50Ω , Standard PC board terminal)
- Sample: ARS144H; Measuring method: Measured with Agilent Technologies network analyzer (E8363B). *For details see No. 7 under "NOTES".
- V.S.W.R. characteristics



 Insertion loss characteristics (without D.U.T. board's loss)



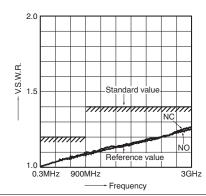
Isolation characteristics



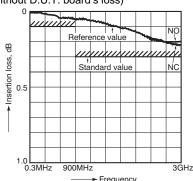
1.-(2) High frequency characteristics (Impedance: 75 Ω , Standard PC board terminal)

Sample: ARS104H; Measuring method: Measured with Agilent Technologies network analyzer (E8363B). *For details see No. 7 under "NOTES".

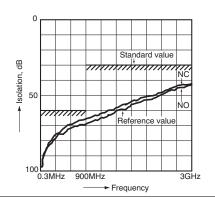
V.S.W.R. characteristics



 Insertion loss characteristics (without D.U.T. board's loss)



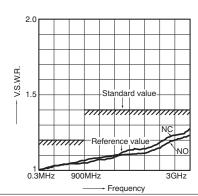
Isolation characteristics



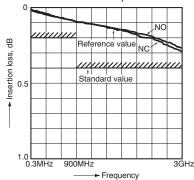
1.-(3) High frequency characteristics (Impedance: 50Ω , Surface-mount terminal)

Sample: ARS14A4H; Measuring method: Measured with Agilent Technologies network analyzer (E8363B). *For details see No. 7 under "NOTES".

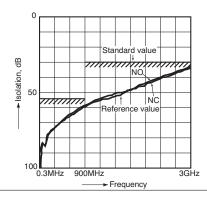
V.S.W.R. characteristics



• Insertion loss characteristics (without D.U.T. board's loss)



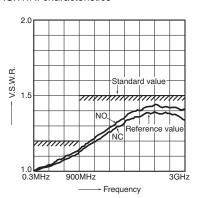
Isolation characteristics



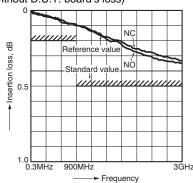
1.-(4) High frequency characteristics (Impedance: 75Ω , Surface-mount terminal)

Sample: ARS10A4H; Measuring method: Measured with Agilent Technologies network analyzer (E8363B). *For details see No. 7 under "NOTES".

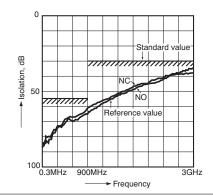
• V.S.W.R. characteristics



 Insertion loss characteristics (without D.U.T. board's loss)



Isolation characteristics



RS

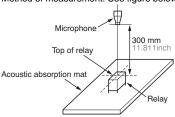
2.-(1) Operation noise distribution

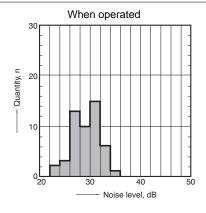
Sample: ARS134H (single side stable silent type),

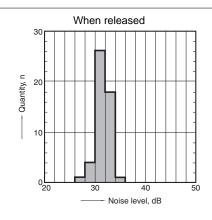
Coil voltage: rated voltage applied (with diode) Equipment setting: A weighted sound pressure level, FAST.

Background noise: approx. 20 dB

Method of measurement: See figure below.







2.-(2) Operation noise distribution

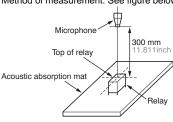
Sample: ARS104H (single side stable standard type),

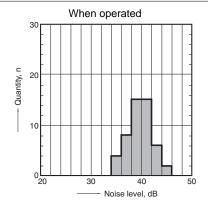
Coil voltage: rated voltage applied (with diode)

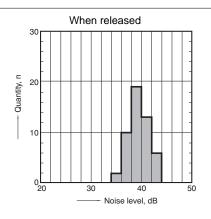
Equipment setting: A weighted sound pressure level, FAST.

Background noise: approx. 20 dB

Method of measurement: See figure below.





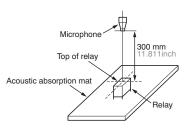


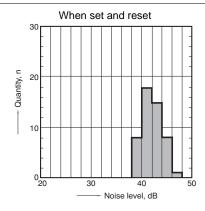
2.-(3) Operation noise distribution

Sample: ARS114H (latching type), 50 pcs. Coil voltage: rated voltage applied (with diode) Equipment setting: A weighted sound pressure level,

Background noise: approx. 20 dB

Method of measurement: See figure below.



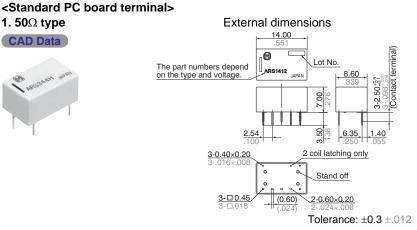


DIMENSIONS (mm inch)

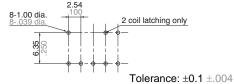
Download **CAD Data** from our Web site.

1. 50Ω type

CAD Data



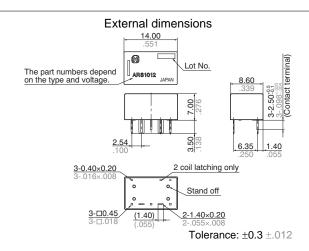
PC board pattern (Bottom view)

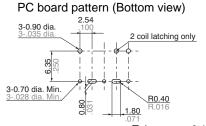


2. 75 Ω type

CAD Data







Tolerance: ±0.1 ±.004

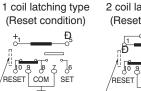
Schematic (Bottom view)

1. Standard contact type Single side stable type (Deenergized condition)





Direction indication

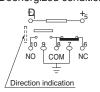


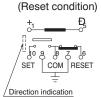




2. Reversed contact type

Single side stable type (Deenergized condition)





1 coil latching type

2 coil latching type (Reset condition)



<Surface-mount terminal>

1. Impedance: 50Ω type

1) E layout **CAD Data**

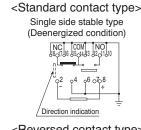




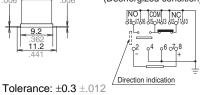
External dimensions

The part numbers depend on the type and voltage 0.5 10.16 14.0 .551 0.15 0.15 8.0 14.6

50000000





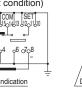


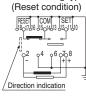
Schematic (Top view)

1 coil latching type (Reset condition)



Direction indication





2-coil latching type

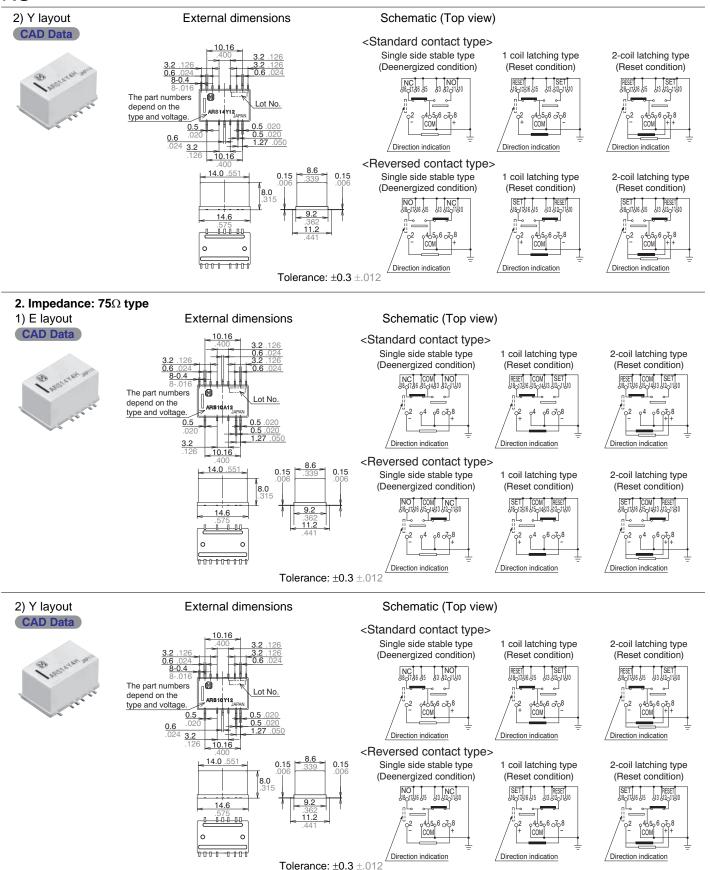


1 coil latching type (Reset condition) 17016 015014013 012011010

Direction indication

ds_61314_en_rs: 010611J

8



NOTES

1. Coil operating power

Pure DC current should be applied to the coil. The wave form should be rectangular. If it includes ripple, the ripple factor should be less than 5%.

However, check it with the actual circuit since the characteristics may be slightly different. The nominal operating voltage should be applied to the coil for more than 30 ms to set/reset the latching type relay.

2. Coil connection

When connecting coils, refer to the wiring diagram to prevent mis-operation or malfunction.

3. External magnetic field

Since RS relays are highly sensitive polarized relays, their characteristics will be affected by a strong external magnetic field. Avoid using the relay under that condition.

4. Cleaning

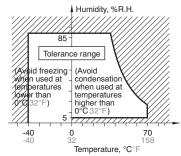
For automatic cleaning, the boiling method is recommended. Avoid ultrasonic cleaning which subjects the relays to high frequency vibrations, which may cause the contacts to stick.

It is recommended that alcoholic solvents be used.

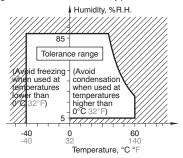
5. Conditions for operation, transport and storage conditions

1) Temperature

- Single side stable standard and latching type: -40 to 70°C -40 to 158°F
- Single side stable silent type: -40 to 60°C -40 to 140°F
- 2) Humidity: 5 to 85% RH (Avoid freezing and condensation.) The humidity range varies with the temperature. Use within the range indicated in the graph below.
- 3) Atmospheric pressure: 86 to 106 kPa Temperature and humidity range for usage, transport, and storage: Single side stable standard and latching type



Single side stable silent type



4) Condensation

Condensation forms when there is a sudden change in temperature under high temperature and high humidity conditions. Condensation will cause deterioration of the relay insulation.

5) Freezing

Condensation or other moisture may freeze on the relay when the temperature is lower than 0°C 32°F. This causes problems such as sticking of movable parts or operational time lags.

6) Low temperature, low humidity environments

The plastic becomes brittle if the relay is exposed to a low temperature, low humidity environment for long periods of time.

7) Storage requirements

Since the relay is sensitive to humidity, the surface-mount type is packaged with tightly sealed anti-humidity packaging. However, when storing, please be careful of the following.

(1) Please use promptly once the antihumidity pack is opened.

If relays are left as is after unpacking, they will absorb moisture which will result in loss of air tightness as a result of case expansion due to thermal stress when reflow soldering during the mounting process. (within one day, 30°C and 60%R.H or less)

- (2) When storing for a log period after opening the anti-humidity pack, storage in anti-humidity packaging with an anti-humidity bag to which silica gel has been added, is recommended.
- *Furthermore, if the relay is solder mounted when it has been subjected to excessive humidity, cracks and leaks can occur. Be sure to mount the relay under the required mounting conditions.

6. Soldering

- 1) Please meet the following conditions if this relay is to be automatically soldered.
- (1) Preheating: Max. 120°C 248°F (terminal solder surface) for max. 120 seconds
- (2) Soldering: Max. 260±5°C 500±9°F for max. 6 seconds

*Relays are influenced by the type of PC board used. Please confirm with the actual PC board you plan to use.

*Please avoid reflow soldering.

Surface-mount terminal

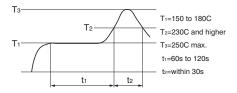
In case of automatic soldering, the following conditions should be observed

(1) Position of measuring temperature



A: Surface of PC board where relay is mounted

(2) IR (infrared reflow) soldering method



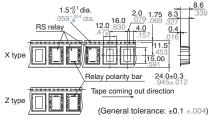
Mounting cautions

Rise in relay temperature depends greatly on the component mix on a given PC board and the heating method of the reflow equipment. Therefore, please test beforehand using actual equipment to ensure that the temperature where the relay terminals are soldered and the temperature at the top of the relay case are within the conditions given above.

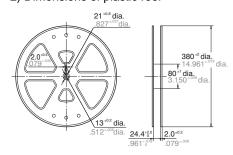
- 3) Please meet the following conditions if this relay is to be soldered by hand.
- (1) 260°C 500°F for max. 10 seconds
- (2) 350°C 662°F for max. 3 seconds The effect on the relay depends on the actual substrate used. Please verify the substrate to be used.
- (3) Avoid ultrasonic cleaning. Doing so will adversely affect relay characteristics. Please use alcohol-based cleaning solvents when cleaning relays.

7. Tape and reel packing

1) Tape dimensions

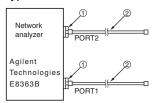


2) Dimensions of plastic reel



8. Measuring method

1) 50Ω type



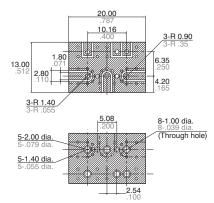
Connect connectors 1 and 2 respectively to PORT 1 and PORT 2. Perform calibration using the 3.5 mm calibration kit (HP85052B).

No.	Product name	Contents
1	Agilent 85130-60011	Adapter 2.4mm-3.5mm female .095inch138inch female
2	SUHNER SUCOFLEX104	Cable 3.5mm-3.5mm male .138inch138inch male

After calibration, connect the D.U.T. board and measure. However, connectors other than those for measurement should be connected with a 50% termination resistor.

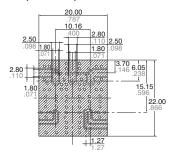
<Standard PC board terminal>

PC board Dimensions (mm inch)



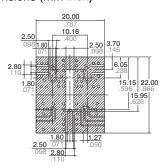
<Surface-mount terminal and E layout>

PC board Dimensions (mm inch)

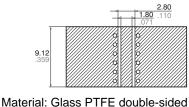


<Surface-mount terminal and Y layout>

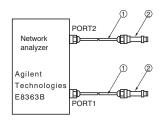
PC board Dimensions (mm inch)



PC board for correction Dimensions (mm inch)



through hole PC board R-4737 (Matsushita Electric Works) Board thickness: t=0.8~mm .031 inch Copper plating: $18~\mu\text{m}$ Connector (SMA type receptacle) Product name: 01K1808-00 (Waka Manufacturing Co., Ltd.) Insertion loss compensation The insertion loss of relay itself is given by subtracting the insertion loss of shortcircuit the Com and the NC (or NO). (signal path and two connectors) $2)~75\Omega$ type



Connect connectors 1 and 2 respectively to PORT 1 and PORT 2, and then perform calibration using the 75Ω F type.

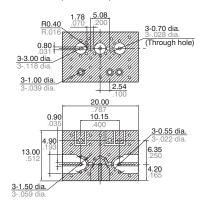
•		0 71
No.	Product name	Contents
1	85134-60003	Test port cable
2	11852B	Conversion adapter; 50Ω N type (female) to 75Ω N type (male)
2	85039-60011	Conversion adapter; 75Ω N type (female) to 75Ω F type (male)

After calibration, connect the D.U.T. board and measure. However, connectors other than those for measurement should be connected with a 75Ω termination resistor.

<Standard PC board terminal>

PC board

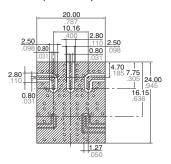
Dimensions (mm inch)



<Surface-mount terminal and E layout>

PC board

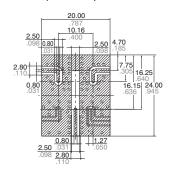
Dimensions (mm inch)



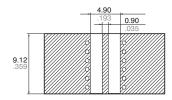
<Surface-mount terminal and Y layout>

PC board

Dimensions (mm inch)



PC board for correction Dimensions (mm inch)



Material: Glass PTFE double-sided through hole PC board R-4737 (Matsushita Electric Works)

Board thickness: t = 0.8 mm .031 inch

Copper plating: 18µm

Connector (F type receptacle)
Product name: C05-0236 (Komine
Musen Electric Corporation)

Insertion loss compensation
The insertion loss of relay itself is given by subtracting the insertion loss of shortcircuit the COM and the NC (or NO). (signal path and two connectors)

9. Others

1) The switching lifetime is defined under the standard test condition specified in the JIS* C 5442 standard (temperature 15 to 35°C 59 to 95°F, humidity 25 to 75%). Check this with the real device as it is affected by coil driving circuit, load type, activation frequency, activation phase, ambient conditions and other factors.

Also, be especially careful of loads such as those listed below.

- When used for AC load-operating and the operating phase is synchronous, rocking and fusing can easily occur due to contact shifting.
- When high-frequency opening and closing of the relay is performed with a load that causes arcs at the contacts, nitrogen and oxygen in the air is fused by the arc energy and HNO₃ is formed. This can corrode metal materials.

Three countermeasures for these are listed here.

- (1) Incorporate an arc-extinguishing circuit.
- (2) Lower the operating frequency
- (3) Lower the ambient humidity
- 2) Use the relay within specifications such as coil rating, contact rating and on/ off service life. If used beyond limits, the relay may overheat, generate smoke or catch fire.
- 3) Be careful not to drop the relay. If accidentally dropped, carefully check its appearance and characteristics before use.
- 4) Be careful to wire the relay correctly. Otherwise, malfunction, overheat, fire or other trouble may occur.
- 5) If a relay stays on in a circuit for many months or years at a time without being activated, circuit design should be reviewed so that the relay can remain non-excited. A coil that receives current all the time heats, which degrades insulation earlier than expected. A latching type relay is recommended for such circuits.

- 6) To ensure accurate operation of the latching type amidst surrounding temperature changes and other factors that might affect the set and reset pulse times, we recommend a coil impress set and reset pulse width of at least 30 ms at the rated operation voltage.
- 7) The latching type relay is shipped in the reset position. But jolts during transport or impacts during installation can change the reset position. It is, therefore, advisable to build a circuit in which the relay can be initialized (set and reset) just after turning on the power.

 8) If silicone materials (e.g., silicone rubbers, silicone oils, silicone coating agents, silicone sealers) are used in the vicinity of the relay, the gas emitted from the silicone may adhere to the contacts of the relay during opening and closing and lead to improper contact. If this is the case, use a material other than silicone.

For Cautions for Use, see Relay Technical Information.